

# SKM 600GA176D



**SEMITRANS® 4**

## Trench IGBT Modules

**SKM 600GA176D**

### Features

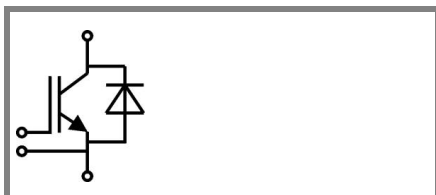
- Homogeneous Si
- Trench = Trenchgate technology
- $V_{CE(sat)}$  with positive temperature coefficient
- High short circuit capability, self limiting to  $6 \times I_C$

### Typical Applications\*

- AC inverter drives mains 575 - 790 V AC
- Public transport (auxiliary systems)

### Remarks

- $I_{DC} \leq 500$  A limited for  $T_{Terminal} = 100^\circ\text{C}$



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Absolute Maximum Ratings		$T_{case} = 25^\circ\text{C}$ , unless otherwise specified		
Symbol	Conditions	Values		Units
<b>IGBT</b>				
$V_{CES}$	$T_j = 25^\circ\text{C}$	1700		V
$I_C$	$T_j = 150^\circ\text{C}$	$T_c = 25^\circ\text{C}$	660	A
		$T_c = 80^\circ\text{C}$	470	A
$I_{CRM}$	$I_{CRM} = 2 \times I_{Cnom}$	800		A
$V_{GES}$		$\pm 20$		V
$t_{psc}$	$V_{CC} = 1200$ V; $V_{GE} \leq 20$ V; $T_j = 125^\circ\text{C}$ $V_{CES} < 1700$ V	10		$\mu\text{s}$
<b>Inverse Diode</b>				
$I_F$	$T_j = 150^\circ\text{C}$	$T_c = 25^\circ\text{C}$	600	A
		$T_c = 80^\circ\text{C}$	410	A
$I_{FRM}$	$I_{FRM} = 2 \times I_{Fnom}$	800		A
$I_{FSM}$	$t_p = 10$ ms; sin.	$T_j = 150^\circ\text{C}$	3800	A
<b>Module</b>				
$I_{t(RMS)}$		500		A
$T_{vj}$		- 40 ... +150		$^\circ\text{C}$
$T_{stg}$		- 40 ... +125		$^\circ\text{C}$
$V_{isol}$	AC, 1 min.	4000		V

Characteristics		$T_{case} = 25^\circ\text{C}$ , unless otherwise specified			
Symbol	Conditions	min.	typ.	max.	Units
<b>IGBT</b>					
$V_{GE(th)}$	$V_{GE} = V_{CE}$ , $I_C = 16$ mA	5,2	5,8	6,4	V
$I_{CES}$	$V_{GE} = 0$ V, $V_{CE} = V_{CES}$			4	mA
$V_{CE0}$		$T_j = 25^\circ\text{C}$	1	1,2	V
		$T_j = 125^\circ\text{C}$	0,9	1,1	V
$r_{CE}$	$V_{GE} = 15$ V	$T_j = 25^\circ\text{C}$	2,5	3,1	m $\Omega$
		$T_j = 125^\circ\text{C}$	3,9	4,5	m $\Omega$
$V_{CE(sat)}$	$I_{Cnom} = 400$ A, $V_{GE} = 15$ V	$T_j = 25^\circ\text{C}_{chiplev.}$	2	2,45	V
		$T_j = 125^\circ\text{C}_{chiplev.}$	2,45	2,9	V
$C_{res}$	$V_{CE} = 25$ , $V_{GE} = 0$ V	$f = 1$ MHz	28,4		nF
$C_{oes}$			1,46		nF
$C_{res}$			1,17		nF
$t_{d(on)}$	$R_{Gon} = 3 \Omega$	$V_{CC} = 1200$ V $I_C = 400$ A	290		ns
$t_r$			70		ns
$E_{on}$	$R_{Goff} = 3 \Omega$	$T_j = 125^\circ\text{C}$ $V_{GE} = \pm 15$ V	255		mJ
$t_{d(off)}$			890		ns
$t_f$			160		ns
$E_{off}$			155		mJ
$R_{th(j-c)}$	per IGBT			0,044	K/W

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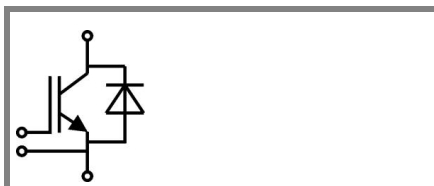
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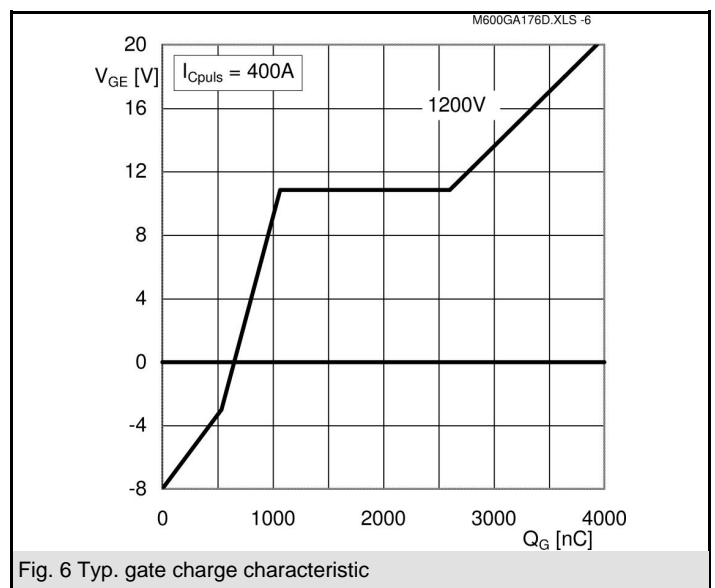
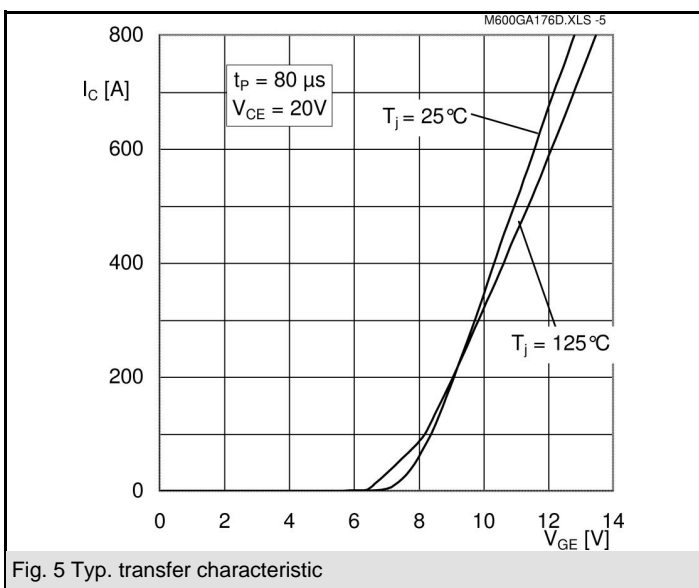
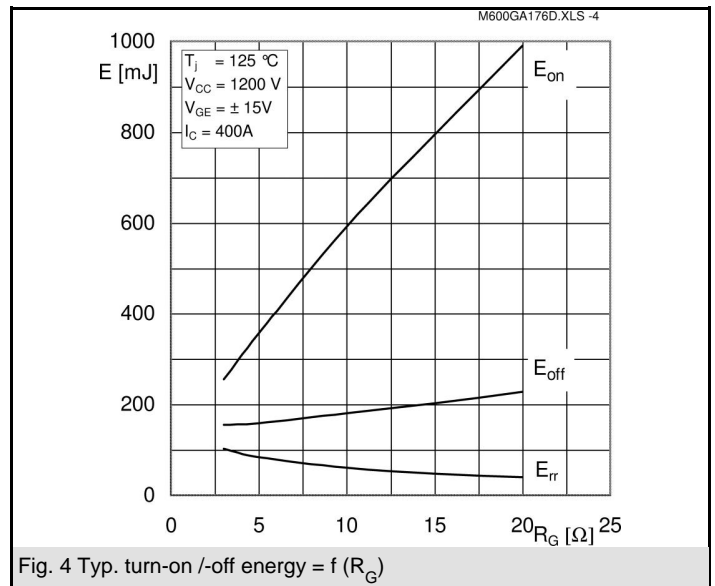
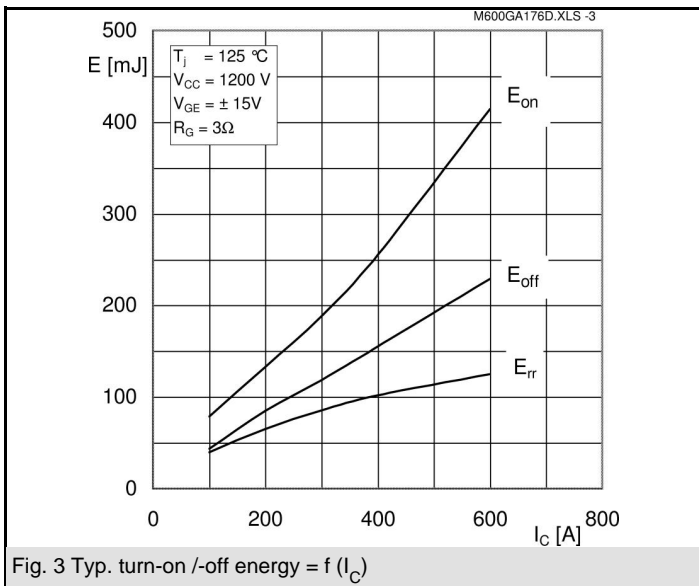
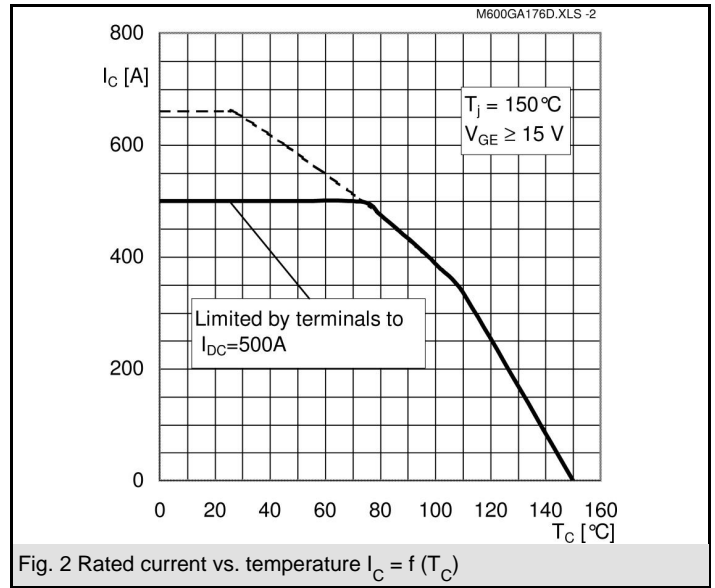
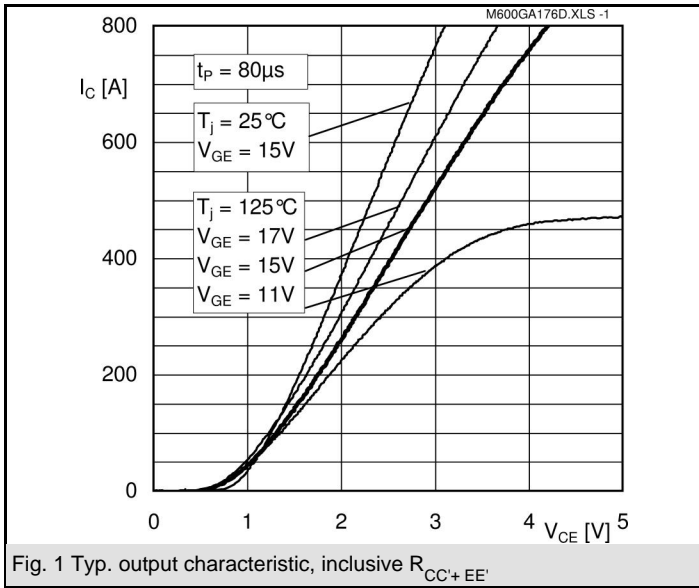
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### Characteristics

Symbol	Conditions	min.	typ.	max.	Units
<b>Inverse Diode</b>					
$V_F = V_{EC}$	$I_{Fnom} = 400$ A; $V_{GE} = 0$ V				
	$T_j = 25^\circ\text{C}_{chiplev.}$		1,6	1,9	V
	$T_j = 125^\circ\text{C}_{chiplev.}$		1,6	1,9	V
$V_{F0}$			1,1	1,3	V
$r_F$			1,3	1,5	mΩ
$I_{RRM}$	$I_F = 400$ A		510		A
$Q_{rr}$	$di/dt = 5700$ A/μs		155		μC
$E_{rr}$	$V_{GE} = -15$ V; $V_{CC} = 1200$ V		102		mJ
$R_{th(j-c)D}$	per diode			0,09	K/W
<b>Module</b>					
$L_{CE}$			15	20	nH
$R_{CC'+EE'}$	res., terminal-chip	$T_{case} = 25^\circ\text{C}$	0,18		mΩ
		$T_{case} = 125^\circ\text{C}$	0,22		mΩ
$R_{th(c-s)}$	per module			0,038	K/W
$M_s$	to heat sink M6		3	5	Nm
$M_t$	to terminals M6 (M4)		2,5 (1,1)	5 (2)	Nm
w				330	g

This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, Chapter IX.

\* The specifications of our components may not be considered as an assurance of component characteristics. Components have to be tested for the respective application. Adjustments may be necessary. The use of SEMIKRON products in life support appliances and systems is subject to prior specification and written approval by SEMIKRON. We therefore strongly recommend prior consultation of our personal.



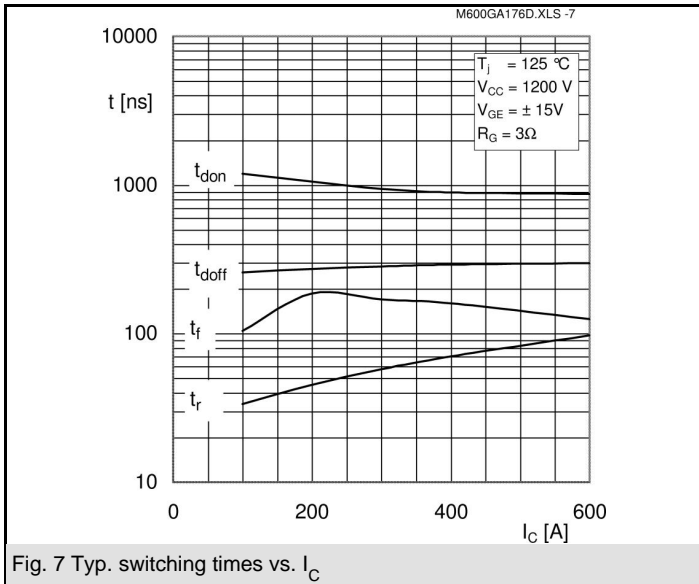


Fig. 7 Typ. switching times vs.  $I_C$

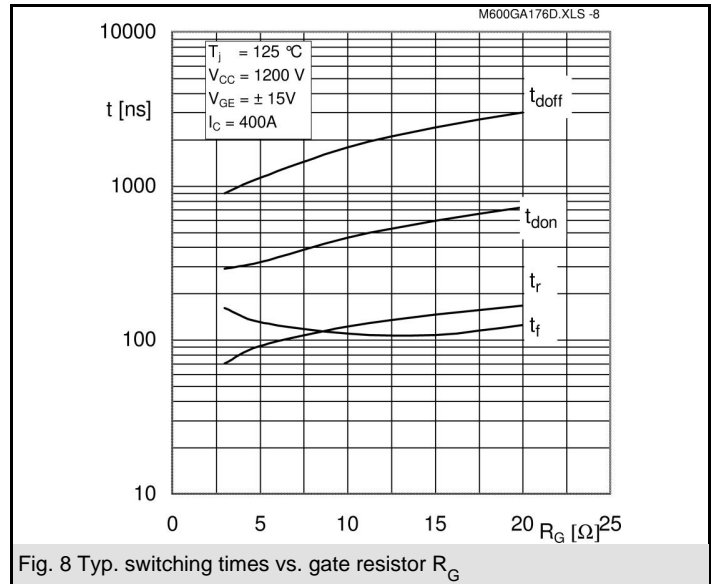


Fig. 8 Typ. switching times vs. gate resistor  $R_G$

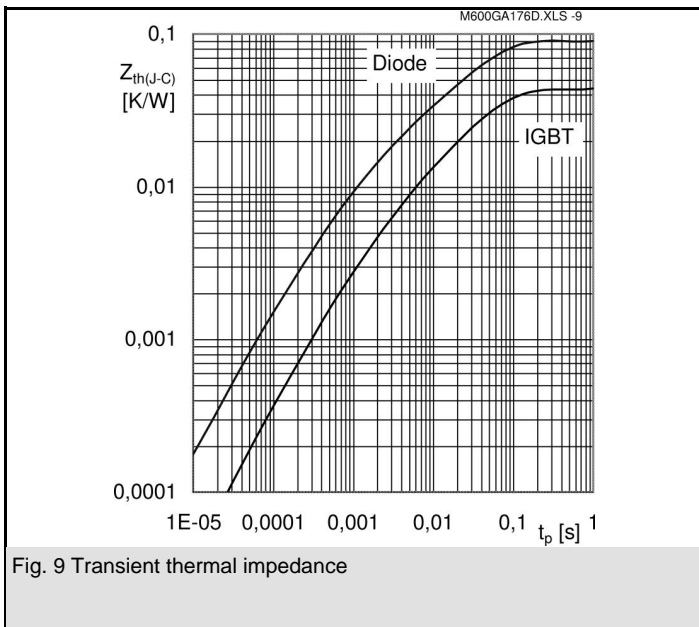


Fig. 9 Transient thermal impedance

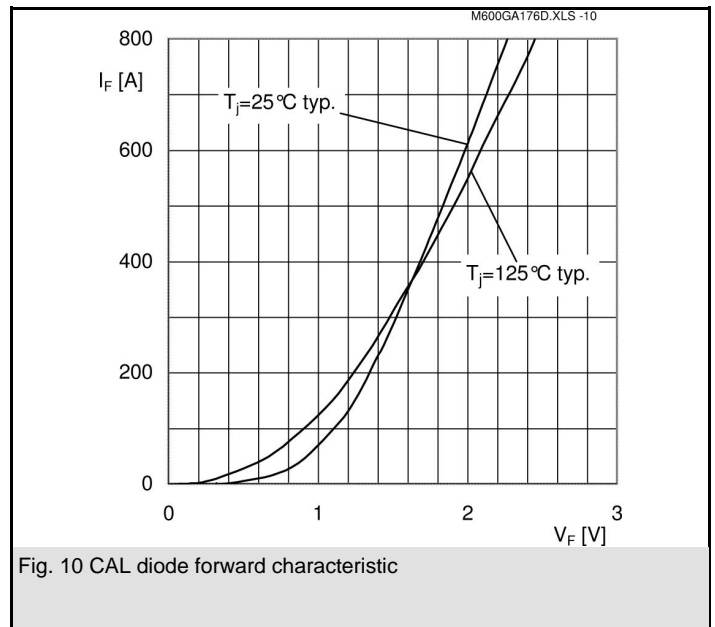


Fig. 10 CAL diode forward characteristic

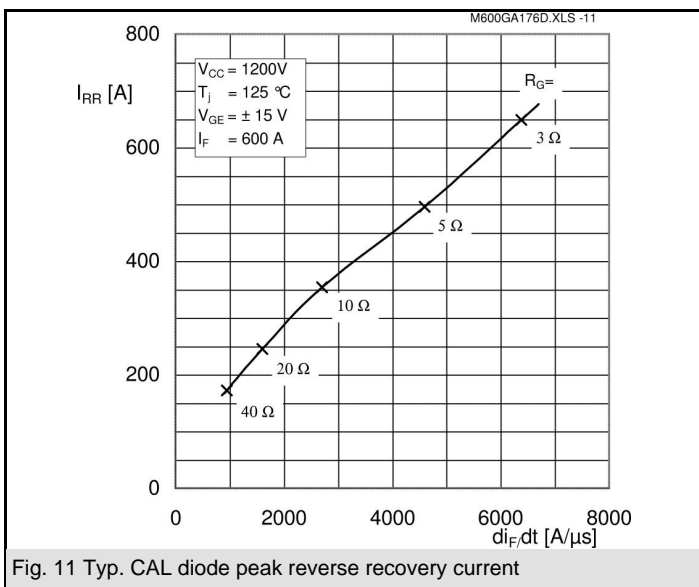


Fig. 11 Typ. CAL diode peak reverse recovery current

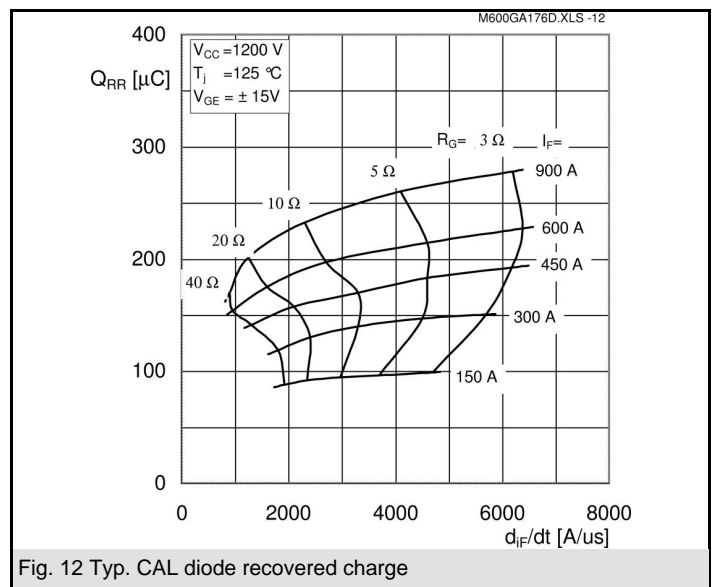


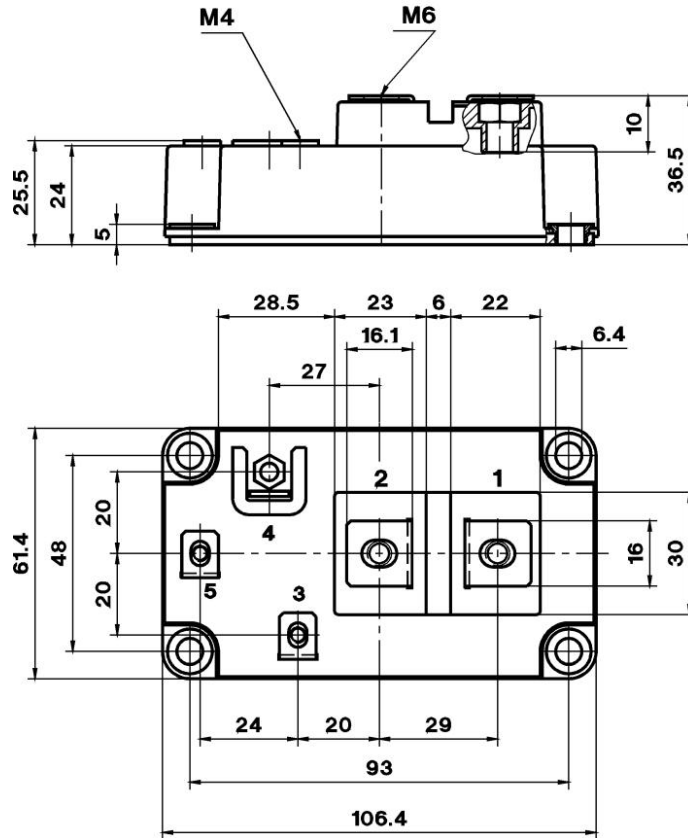
Fig. 12 Typ. CAL diode recovered charge

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UL Recognized

CASED59

File no. 63 532



Case D 59

